



600V SiC Power Module Dual Diode Pack

VDC	600 V
I _F	50 A
T _j ,max	175 °C

Features

- · SiC Schottky Diode
 - Zero reverse recovery
 - Zero forward recovery
 - Temperature independent switching behavior
 - Positive temperature coefficient on V_F
- · Low stray inductance
- High junction temperature operation
- All parts tested to greater than 715V

Package







Parallel

Benefits

- Outstanding performance at high frequency operation
- · Low loss and low EMI noise
- · Very rugged and easy mounting
- Internally isolated package (AIN)
- · Low junction to case thermal resistance
- Easy paralleling due to positive T_C of V_F
- RoHS compliant

Part #	Package	Marking
GHXS050A060S-D3	SOT-227	GHXS050A060S-D3

Applications

- Switched-mode power supply
- Induction heater
- Welding equipment
- · Charging station



Maximum Ratings, at T_i=25 °C, unless otherwise specified (per leg)

Characteristics	Symbol	Conditions	Values	Unit	
		T _C =25 °C, T _j =175 °C	129		
Continuous forward current	I _{F*}	T _C =143 °C, T _j =175 °C	50	Α	
		T _C =150 °C, T _j =175 °C	42		
Surge non-repetitive forward current		T _C =25 °C, t _p =8.3 ms	420	۸	
sine halfwave	I _{FSM}	T _C =110 °C, t _p =8.3 ms	390	A	
Non-repetitive peak forward current	I _{F,max}	T _C =25 °C, t _p =10 μs	2000**	Α	
² value	∫ ²	T _C =25 °C, t _p =8.3 ms	732	A ² s	
		T _C =110 °C, t _p =8.3 ms	631		
Repetitive peak reverse voltage	V_{RRM}	T _j =25 °C	600	V	
Diode ruggedness		Turn-on slew rate, repetitive	200	V/ns	
Power dissipation	P _{tot*}	T _C =25 °C	386	W	
Operating junction temperature	T _j		-55175	°C	
Storage temperature	T _{storage}		-55150	°C	

Notes: *Typical Rth_{JC} used

^{**}Limited by testing equipment

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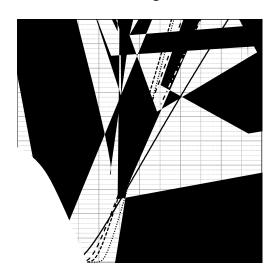
Electrical Characteristics, at T_j =25 °C, unless otherwise specified (per leg)

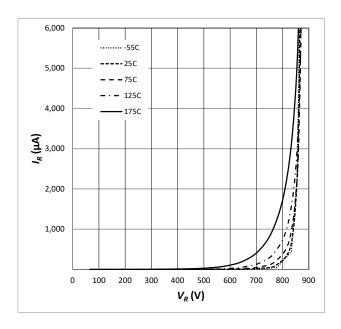
Characteristics	Sumb al	Conditions		Values		
	Symbol		min.	typ.	max.	Unit
DC blocking voltage	V _{DC}	I _R =120μA, _T j=25 °C	600	-	-	V
Breakdown voltage	V_{BR}	I _R =1.58mA, T _j =25 °C	715	-	-	V
		I _F =50A, T _j =25 °C	-	1.48	1.60	
Diode forward voltage	V _F	I _F =50A, T _j =125 °C	-	1.58	-	V
		I _F =50A, T _j =175 °C	-	1.64	2.00	1
		V _R =600V, T _j =25 °C	-	3	120	
Deverse surrent		V _R =715V, T _j =25 °C	-	27	-	1
Reverse current	l _R	V _R =600V, T _j =125 °C	-	26	-	μΑ
		V _R =600V, T _j =175 °C	-	104	800	
Total capacitive charge	Q _C	V _R =400V, T _j =25 °C	-	144	-	nC
		V _R =1V, f=1 MHz	-	2285	-	
Total capacitance	С	V _R =200V, f=1 MHz	-	272	-	pF
		V _R =400V, f=1 MHz	-	227	-	1

Thermal and Package Characteristics, at T_j =25 °C, unless otherwise specified

Characteristics	ics Symbol	Conditions	Values			Unit
Citalacteristics			min.	typ.	max.	Oilit
Thermal resistance, junction-case	R _{thJC}	Per leg	-	0.39	0.50	°C/W
Mounting torque	M _d	M4-0.7 screws	1.1	-	1.5	N-m
Terminal connection torque	M _{dt}	M4-0.7 screws	-	1.1	1.3	N-m
Package weight	W _t		-	32	-	g
Isolation voltage	V _{ISOL}	I _{ISOL} < 1mA, 50/60 Hz, 1 min	2500	-	-	V

Typical Performance Per Leg

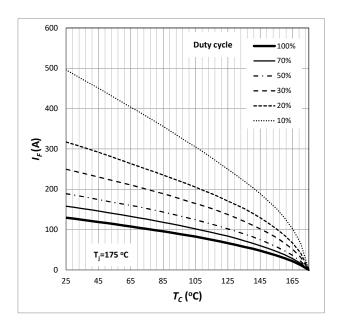




450 400 350 300 **A** 2000 **S** 2200 150 100 50 T_i=175 °C 25 45 65 85 105 125 145 165 T_c (°C)

Fig. 3 Reverse Characteristics (parameterized on Tj)

Fig. 4 Power Derating



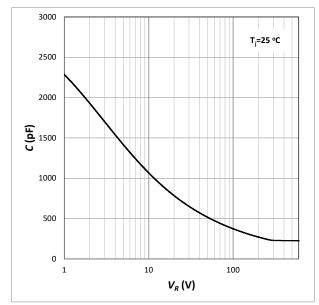
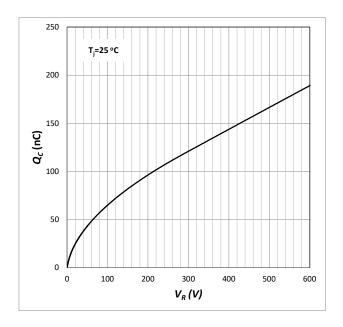


Fig. 5 Current Derating

Fig. 6 Capacitance

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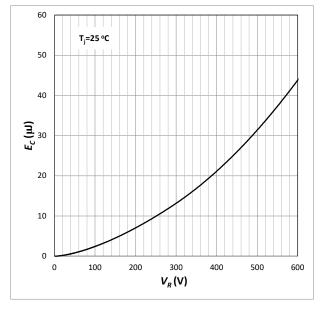


Fig. 7 Capacitive Charge

Fig. 8 Typical Capacitance Stored Energy

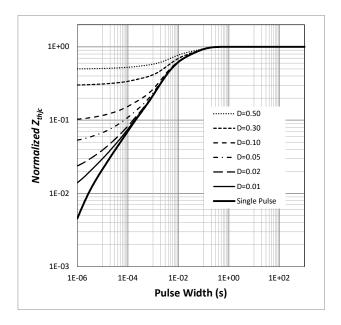
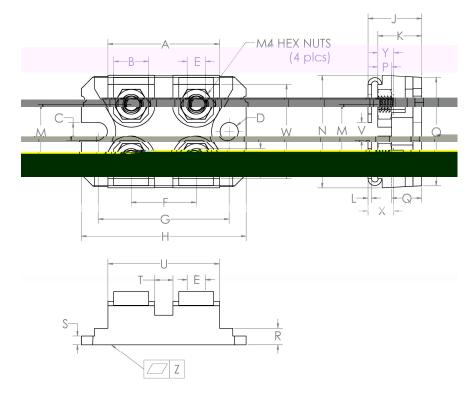


Fig. 9 Transient Thermal Impedance

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Package Dimensions SOT-227



Cuma	Millimeters		Inc	ches	
Sym	Min	Max	Min	Max	
Α	31.67	31.90	1.247	1.256	
В	7.95	8.18	0.313	0.322	
С	4.14	4.24	0.163	0.167	
D	4.14	4.24	0.163	0.167	
Е	4.14	4.24	0.163	0.167	
F	14.94	15.09	0.588	0.594	
G	30.15	30.25	1.187	1.191	
Н	38.00	38.10	1.496	1.500	
I	4.75	4.83	0.187	0.190	
J	11.68	12.19	0.460	0.480	
K	9.45	9.60	0.372	0.378	
L	0.76	0.84	0.030	0.033	
М	12.62	12.88	0.497	0.507	
N	25.15	25.30	0.990	0.996	
0	24.79	25.04	0.976	0.986	
Р	3.02	3.15	0.119	0.124	
Q	6.71	6.96	0.264	0.274	
R	4.17	4.42	0.164	0.174	
S	2.08	2.13	0.082	0.084	
Т	3.28	3.63	0.129	0.143	
U	26.75	26.90	1.053	1.059	
V	3.86	4.24	0.152	0.167	
W	20.55	26.90	0.809	0.814	
Х	5.45	5.85	0.215	0.230	
Y	3.15	3.66	0.124	0.144	
Z	0.00	0.13	0.000	0.005	

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Revision History

Date	Revision	Notes
9/6/2011	1.0	Initial release
6/4/2014	1.1	Add the part number, pin assignment table.
1/3/2020	1.2	Applied company name change.
12/4/2020	1.3	Updated parameters.

Notes

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of www.SemiQ.com.

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